



To reduce winding and diode dissipation the secondary is split into two windings and diode OR'ed into the output capacitors (C2, 3). Regulation is provided by a secondary side reference (U3), the output voltage sensed by R4, R13 and R6.

## Key Design Points

- D1 and VR1 clamp leakage inductance spikes. A Zener clamp provides lower zero load consumption than an RCD clamp and higher efficiency below full load.
- C11 reduces VR1 dissipation, raising efficiency.
- Additional differential filtering is provided by C13 and L3.
- C12 provides high frequency bypass, reducing high frequency EMI.
- Use foil windings to reduce dissipation and reduce leakage inductance.
- Sandwich secondary winding between two halves of primary to reduce leakage inductance.
- High core temperature reduces saturation flux density. Keep flux density below 3000 gauss (0.3 T) to prevent saturation.
- Use 100 V Schottky diodes for highest efficiency.
- Good layout practices should be followed:
  - Locate C8, R3, C5, R9, R10 and R11 close to U1.
  - Power and signal source currents should be separated, joined using a Kelvin connection at the SOURCE pin.
  - Minimize the primary and secondary loop areas to reduce parasitic leakage and EMI.
- Consult DAK-11 and EPR-11 for more information.

TRANSFORMER PARAMETERS	
Core Material	FPQ26/20-A TDK PC40 gapped for $A_{LE} = 843 \text{ nH/T}^2$
Bobbin	TDK BPQ26/20-1112CP
Winding Details	Primary: 9T + 9T, 2 x 26 AWG Shield: 1T, 8 mm x 0.015 mm Cu foil Secondary 1: 3T, 3 x 26 AWG T.I.W. Secondary 2: 3T, 3 x 26 AWG T.I.W. Bias: 2T, 8 mm x 0.015 mm Cu foil (T.I.W. = Triple Insulated Wire)
Winding Order (Pin Numbers)	Primary (2-1), Shield (1-NC), tape, Secondary 1 (12-9), Secondary 2 (11-8), Bias (6-5), tape, Primary (3-2), tape
Inductance	Primary: 273 $\mu\text{H} \pm 10\%$ , Leakge: 3 $\mu\text{H}$ (maximum)
Primary Resonant Frequency	1.5 MHz (minimum)

Table 1. Transformer Construction Information.

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